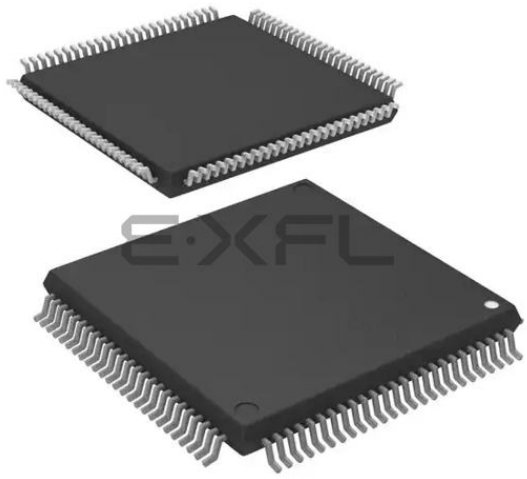
Renesas Electronics America Inc - M30843FHGP#U3 Datasheet



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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	M32C/80
Core Size	16/32-Bit
Speed	32MHz
Connectivity	CANbus, I²C, IEBus, SIO, UART/USART
Peripherals	DMA, PWM, WDT
Number of I/O	85
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	24K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 26x10b; D/A 2x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-LQFP
Supplier Device Package	100-LFQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30843fhgp-u3

1.2 Performance Overview

Tables 1.1 and 1.2 list performance overview of the M32C/84 group (M32C/84, M32C/84T).

Table 1.1 M32C/84 Group (M32C/84, M32C/84T) Performance (144-Pin Package)

Characteristic		Performance	
		M32C/84	M32C/84T
CPU	Basic Instructions	108 instructions	
	Shortest Instruction Execution Time	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V) 41.7 ns (f(BCLK)=24 MHz, V_{CC1}=3.0 V to 5.5 V)	31.3 ns (f(BCLK)=32 MHz, V_{CC1}=4.2 V to 5.5 V)
	Operation Mode	Single-chip mode, Memory expansion mode and Microprocessor mode	Single-chip mode
	Address Space	16 Mbytes	
	Memory Capacity	See Table 1.3	
Peripheral Function	I/O Port	123 I/O pins and 1 input pin	
	Multifunction Timer	Timer A: 16 bits x 5 channels, Timer B: 16 bits x 6 channels Three-phase motor control circuit	
	Intelligent I/O	Time measurement function or Waveform generating function: 16 bits x 8 channels Communication function (Clock synchronous serial I/O, Clock asynchronous serial I/O, HDLC data processing)	
	Serial I/O	5 Channels Clock synchronous serial I/O, Clock asynchronous serial I/O, IEBus(1), I^2C bus(2)	
	CAN Module	1 channel Supporting CAN 2.0B specification	
	A/D Converter	10-bit A/D converter: 1 circuit, 34 channels	
	D/A Converter	8 bits x 2 channels	
	DMAC	4 channels	
	DMAC II	Can be activated by all peripheral function interrupt sources Immediate transfer, Calculation transfer and Chain transfer functions	
	CRC Calculation Circuit	CRC-CCITT	
	X/Y Converter	16 bits x 16 bits	
	Watchdog Timer	15 bits x 1 channel (with prescaler)	
	Interrupt	38 internal and 8 external sources, 5 software sources Interrupt priority level: 7	
	Clock Generation Circuit	4 circuits Main clock oscillation circuit(*), Sub clock oscillation circuit(*), On-chip oscillator, PLL frequency synthesizer (*)Equipped with a built-in feedback resistor. Ceramic resonator or crystal oscillator must be connected externally	
	Oscillation Stop Detect Function	Main clock oscillation stop detect function	
	Voltage Detection Circuit	Available (optional)	Not available(4)
Electrical Characteristics	Supply Voltage	V_{CC1}=4.2 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=32 MHz) V_{CC1}=3.0 V to 5.5 V, V_{CC2}=3.0 V to V_{CC1} (f(BCLK)=24 MHz)	V_{CC1}=V_{CC2}=4.2 V to 5.5 V, (f(BCLK)=32 MHz)(3)
	Power Consumption	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 22 mA (V_{CC1}=V_{CC2}=3.3 V, f(BCLK)=24 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)	28 mA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 MHz) 10µA (V_{CC1}=V_{CC2}=5 V, f(BCLK)=32 kHz, in wait mode)
Flash Memory	Program/Erase Supply Voltage	3.3 V ± 0.3 V or 5.0 V ± 0.5 V	5.0 V ± 0.5 V
	Program and Erase Endurance	100 times (all space)	
Operating Ambient Temperature		–20 to 85°C –40 to 85°C (optional)	–40 to 85°C (T version)
Package		144-pin plastic molded LQFP	

NOTES:
1. IEBus is a trademark of NEC Electronics Corporation.
2. I^2C bus is a trademark of Koninklijke Philips Electronics N. V.
3. The supply voltage of M32C/84T (High-reliability version) must be V_{CC1}=V_{CC2}.
4. The cold start-up/warm start-up determine function is available only at the user's option.

All options are on a request basis.

1.4 Product Information

Table 1.3 lists product information. Figure 1.2 shows the product numbering system.

Table 1.3 M32C/84 Group (1) (M32C/84) **As of July, 2005**

Type Number	Package	ROM Capacity	RAM Capacity	Remarks
M30845FJGP	PLQP0144KA-A (144P6Q-A)	512K+4K	24K	Flash Memory
M30843FJGP	PLQP0100KB-A (100P6Q-A)			
M30843FJFP	PRQP0100JB-A (100P6S-A)			
M30845FHGP	PLQP0144KA-A (144P6Q-A)	384K+4K		
M30843FHGP	PLQP0100KB-A (100P6Q-A)			
M30843FHFP	PRQP0100JB-A (100P6S-A)			
M30845FWGP	PLQP0144KA-A (144P6Q-A)	320K+4K		
M30843FWGP	PLQP0100KB-A (100P6Q-A)			
M30845MW-XXXGP	PLQP0144KA-A (144P6Q-A)	320K		Mask ROM
M30843MW-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30843MW-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842ME-XXXGP	PLQP0144KA-A (144P6Q-A)	192K	16K	
M30840ME-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30840ME-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842MC-XXXGP	PLQP0144KA-A (144P6Q-A)	128K	10K	
M30840MC-XXXGP	PLQP0100KB-A (100P6Q-A)			
M30840MC-XXXFP	PRQP0100JB-A (100P6S-A)			
M30842SGP (D)	PLQP0144KA-A (144P6Q-A)	---		ROMless
M30840SGP (D)	PLQP0100KB-A (100P6Q-A)			
M30840SFP (D)	PRQP0100JB-A (100P6S-A)			

(D): Under Development

Table 1.3 M32C/84 Group (2) (T Version, M32C/84T) **As of July, 2005**

Type Number	Package	ROM Capacity	RAM Capacity	Remarks
M30845FJTGP	PLQP0144KA-A (144P6Q-A)	512K+4K	24K	Flash Memory T Version (High-releability 85° C Version)
M30843FJTGP	PLQP0100KB-A (100P6Q-A)			
M30845FHTGP	PLQP0144KA-A (144P6Q-A)	384K+4K		
M30843FHTGP	PLQP0100KB-A (100P6Q-A)			
M30843FWTGP	PLQP0100KB-A (100P6Q-A)	320K+4K		
M30842MCT-XXXGP (D)	PLQP0144KA-A (144P6Q-A)	128K	10K	Mask ROM
M30840MCT-XXXGP (D)	PLQP0100KB-A (100P6Q-A)			

(D): Under Development

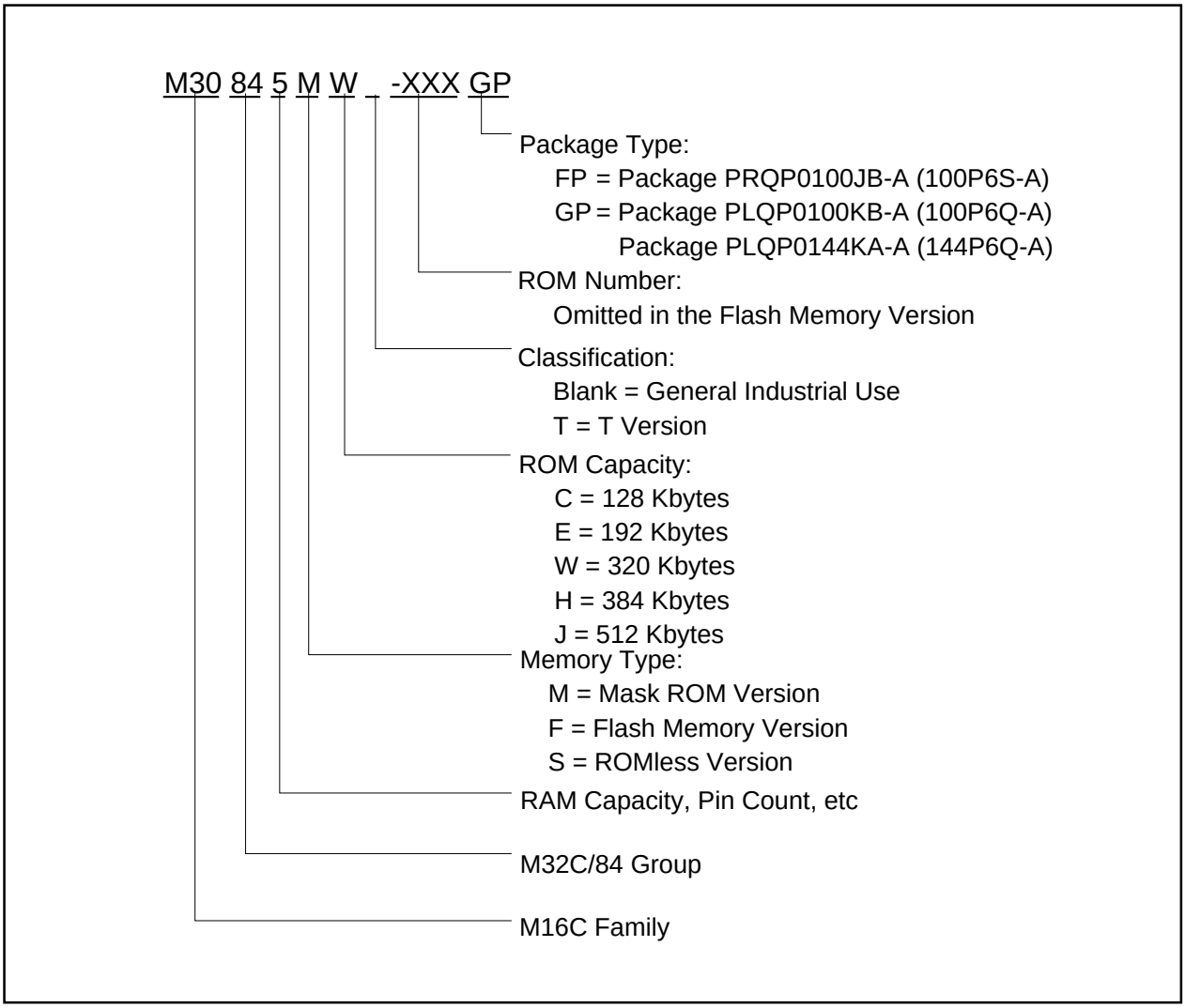


Figure 1.2 Product Numbering System

1.5 Pin Assignments and Descriptions

Figures 1.3 to 1.5 show pin assignments (top view).

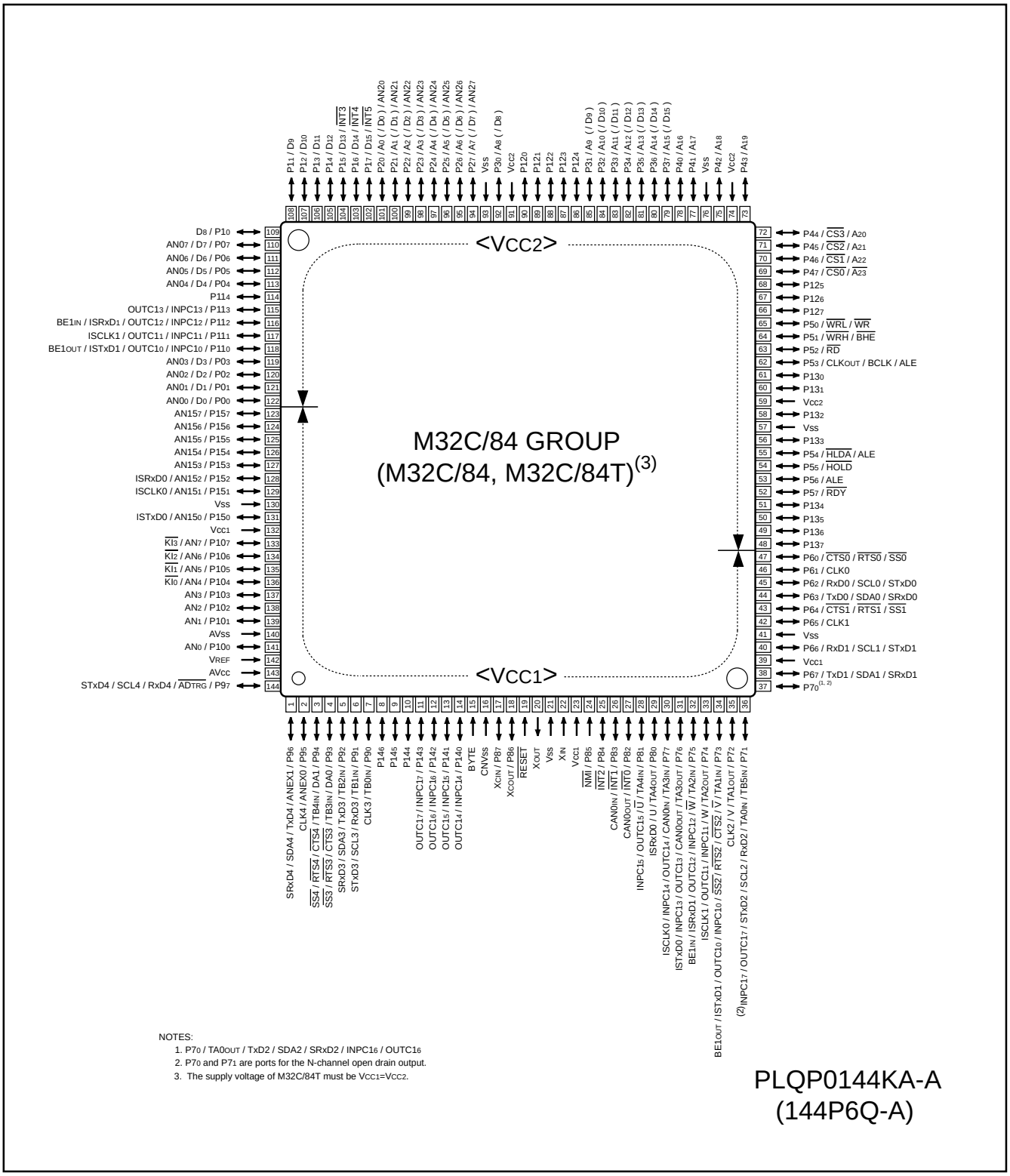


Figure 1.3 Pin Assignment for 144-Pin Package

Table 1.4 Pin Characteristics for 144-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
49		P13$_6$						
50		P13$_5$						
51		P13$_4$						
52		P5$_7$						$\overline{\text{RDY}}$
53		P5$_6$						ALE
54		P5$_5$						$\overline{\text{HOLD}}$
55		P5$_4$						$\overline{\text{HLDA}}$/ALE
56		P13$_3$						
57	V_{SS}							
58		P13$_2$						
59	V_{CC2}							
60		P13$_1$						
61		P13$_0$						
62		P5$_3$						CLK$_{OUT}$/BCLK/ALE
63		P5$_2$						$\overline{\text{RD}}$
64		P5$_1$						$\overline{\text{WRH}}$/$\overline{\text{BHE}}$
65		P5$_0$						$\overline{\text{WRL}}$/$\overline{\text{WR}}$
66		P12$_7$						
67		P12$_6$						
68		P12$_5$						
69		P4$_7$						$\overline{\text{CS0}}$/A$_{23}$
70		P4$_6$						$\overline{\text{CS1}}$/A$_{22}$
71		P4$_5$						$\overline{\text{CS2}}$/A$_{21}$
72		P4$_4$						$\overline{\text{CS3}}$/A$_{20}$
73		P4$_3$						A$_{19}$
74	V_{CC2}							
75		P4$_2$						A$_{18}$
76	V_{SS}							
77		P4$_1$						A$_{17}$
78		P4$_0$						A$_{16}$
79		P3$_7$						A$_{15}$(/D$_{15}$)
80		P3$_6$						A$_{14}$(/D$_{14}$)
81		P3$_5$						A$_{13}$(/D$_{13}$)
82		P3$_4$						A$_{12}$(/D$_{12}$)
83		P3$_3$						A$_{11}$(/D$_{11}$)
84		P3$_2$						A$_{10}$(/D$_{10}$)
85		P3$_1$						A$_9$(/D$_9$)
86		P12$_4$						
87		P12$_3$						
88		P12$_2$						
89		P12$_1$						
90		P12$_0$						
91	V_{CC2}							
92		P3$_0$						A$_8$(/D$_8$)
93	V_{SS}							
94		P2$_7$					AN2$_7$	A$_7$(/D$_7$)
95		P2$_6$					AN2$_6$	A$_6$(/D$_6$)
96		P2$_5$					AN2$_5$	A$_5$(/D$_5$)

NOTES:
1. Bus control pins in M32C/84T cannot be used.

Table 1.5 Pin Characteristics for 100-Pin Package (Continued)

Package Pin No.		Control Pin	Port	Interrupt Pin	Timer Pin	UART/CAN Pin	Intelligent I/O Pin	Analog Pin	Bus Control Pin
FP	GP								
51	49		$P4_3$						A_{19}
52	50		$P4_2$						A_{18}
53	51		$P4_1$						A_{17}
54	52		$P4_0$						A_{16}
55	53		$P3_7$						A_{15}(/D_{15})
56	54		$P3_6$						A_{14}(/D_{14})
57	55		$P3_5$						A_{13}(/D_{13})
58	56		$P3_4$						A_{12}(/D_{12})
59	57		$P3_3$						A_{11}(/D_{11})
60	58		$P3_2$						A_{10}(/D_{10})
61	59		$P3_1$						A_9(/D_9)
62	60	V_{CC2}							
63	61		$P3_0$						A_8(/D_8)
64	62	V_{SS}							
65	63		$P2_7$					$AN2_7$	A_7(/D_7)
66	64		$P2_6$					$AN2_6$	A_6(/D_6)
67	65		$P2_5$					$AN2_5$	A_5(/D_5)
68	66		$P2_4$					$AN2_4$	A_4(/D_4)
69	67		$P2_3$					$AN2_3$	A_3(/D_3)
70	68		$P2_2$					$AN2_2$	A_2(/D_2)
71	69		$P2_1$					$AN2_1$	A_1(/D_1)
72	70		$P2_0$					$AN2_0$	A_0(/D_0)
73	71		$P1_7$	$\overline{INT5}$					D_{15}
74	72		$P1_6$	$\overline{INT4}$					D_{14}
75	73		$P1_5$	$\overline{INT3}$					D_{13}
76	74		$P1_4$						D_{12}
77	75		$P1_3$						D_{11}
78	76		$P1_2$						D_{10}
79	77		$P1_1$						D_9
80	78		$P1_0$						D_8
81	79		$P0_7$					$AN0_7$	D_7
82	80		$P0_6$					$AN0_6$	D_6
83	81		$P0_5$					$AN0_5$	D_5
84	82		$P0_4$					$AN0_4$	D_4
85	83		$P0_3$					$AN0_3$	D_3
86	84		$P0_2$					$AN0_2$	D_2
87	85		$P0_1$					$AN0_1$	D_1
88	86		$P0_0$					$AN0_0$	D_0
89	87		$P10_7$	$\overline{KI_3}$				AN_7	
90	88		$P10_6$	$\overline{KI_2}$				AN_6	
91	89		$P10_5$	$\overline{KI_1}$				AN_5	
92	90		$P10_4$	$\overline{KI_0}$				AN_4	
93	91		$P10_3$					AN_3	
94	92		$P10_2$					AN_2	
95	93		$P10_1$					AN_1	
96	94	AV_{SS}							
97	95		$P10_0$					AN_0	
98	96	V_{REF}							
99	97	AV_{CC}							
100	98		$P9_7$			RxD4/SCL4/STxD4		$\overline{ADTRG}$	

NOTES:
1. Bus control pins in M32C/84T cannot be used.

2.1 General Registers

2.1.1 Data Registers (R0, R1, R2 and R3)

R0, R1, R2 and R3 are 16-bit registers for transfer, arithmetic and logic operations. R0 and R1 can be split into high-order bits (R0H) and low-order bits (R0L) to be used separately as 8-bit data registers. R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R3.

2.1.2 Address Registers (A0 and A1)

A0 and A1 are 24-bit registers for A0-/A1-indirect addressing, A0-/A1-relative addressing, transfer, arithmetic and logic operations.

2.1.3 Static Base Register (SB)

SB is a 24-bit register for SB-relative addressing.

2.1.4 Frame Base Register (FB)

FB is a 24-bit register for FB-relative addressing.

2.1.5 Program Counter (PC)

PC, 24 bits wide, indicates the address of an instruction to be executed.

2.1.6 Interrupt Table Register (INTB)

INTB is a 24-bit register indicating the starting address of an relocatable interrupt vector table.

2.1.7 User Stack Pointer (USP), Interrupt Stack Pointer (ISP)

The stack pointers (SP), USP and ISP, are 24 bits wide each. The U flag is used to switch between USP and ISP. Refer to **2.1.8 Flag Register (FLG)** for details on the U flag. Set USP and ISP to even addresses to execute an interrupt sequence efficiently.

2.1.8 Flag Register (FLG)

FLG is a 16-bit register indicating a CPU state.

2.1.8.1 Carry Flag (C)

The C flag indicates whether carry or borrow has occurred after executing an instruction.

2.1.8.2 Debug Flag (D)

The D flag is for debug only. Set to "0".

2.1.8.3 Zero Flag (Z)

The Z flag is set to "1" when the value of zero is obtained from an arithmetic operation; otherwise "0".

2.1.8.4 Sign Flag (S)

The S flag is set to "1" when a negative value is obtained from an arithmetic operation; otherwise "0".

3. Memory

Figure 3.1 shows a memory map of the M32C/84 group (M32C/84, M32C/84T).

The M32C/84 group (M32C/84, M32C/84T) provides 16-Mbyte address space from addresses 000000$_{16}$ to FFFFFF$_{16}$.

The internal ROM is allocated lower addresses beginning with address FFFFFF$_{16}$. For example, a 64-Kbyte internal ROM is allocated in addresses FF0000$_{16}$ to FFFFFF$_{16}$.

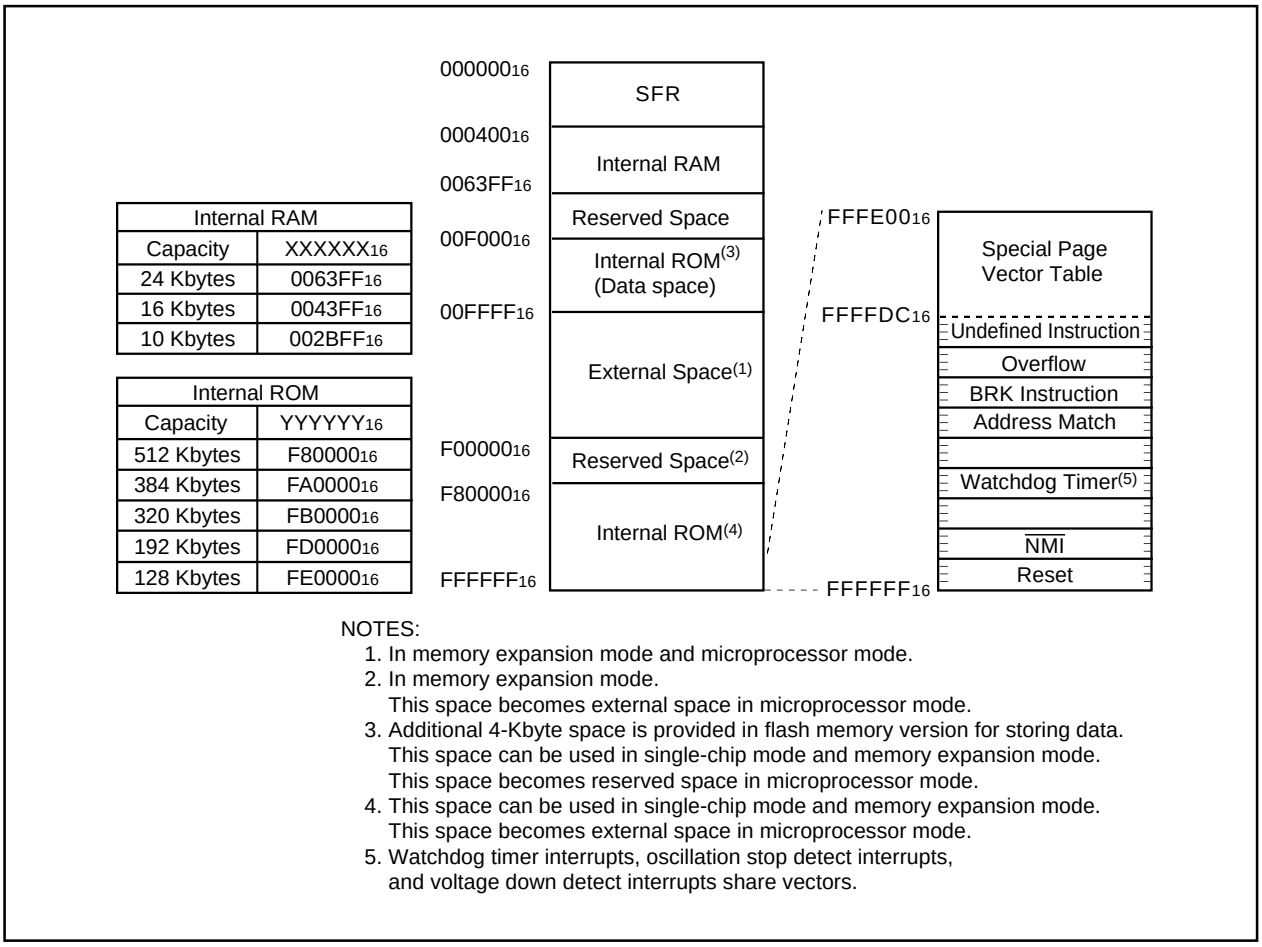
The fixed interrupt vectors are allocated addresses FFFFDC$_{16}$ to FFFFFF$_{16}$. It stores the starting address of each interrupt routine.

The internal RAM is allocated higher addresses beginning with address 000400$_{16}$. For example, a 10-Kbyte internal RAM is allocated addresses 000400$_{16}$ to 002BFF$_{16}$. Besides storing data, it becomes stacks when the subroutine is called or an interrupt is acknowleged.

SFR, consisting of control registers for peripheral functions such as I/O port, A/D converter, serial I/O, and timers, is allocated addresses 000000$_{16}$ to 0003FF$_{16}$. All blank spaces within SFR are reserved and cannot be accessed by users.

The special page vectors are allocated addresses FFFE00$_{16}$ to FFFFDB$_{16}$. It is used for the JMPS instruction and JSRS instruction. Refer to the Renesas publication **M32C/80 Series Software Manual** for details.

In memory expansion mode and microprocessor mode, some spaces are reserved and cannot be accessed by users.



Internal RAM	
Capacity	XXXXXX$_{16}$
24 Kbytes	0063FF$_{16}$
16 Kbytes	0043FF$_{16}$
10 Kbytes	002BFF$_{16}$

Internal ROM	
Capacity	YYYYYY$_{16}$
512 Kbytes	F80000$_{16}$
384 Kbytes	FA0000$_{16}$
320 Kbytes	FB0000$_{16}$
192 Kbytes	FD0000$_{16}$
128 Kbytes	FE0000$_{16}$

NOTES:
1. In memory expansion mode and microprocessor mode.
2. In memory expansion mode.
   This space becomes external space in microprocessor mode.
3. Additional 4-Kbyte space is provided in flash memory version for storing data.
   This space can be used in single-chip mode and memory expansion mode.
   This space becomes reserved space in microprocessor mode.
4. This space can be used in single-chip mode and memory expansion mode.
   This space becomes external space in microprocessor mode.
5. Watchdog timer interrupts, oscillation stop detect interrupts, and voltage down detect interrupts share vectors.

Figure 3.1 Memory Map

Address	Register	Symbol	Value after RESET
006016			
006116			
006216			
006316			
006416			
006516			
006616			
006716			
006816	DMA0 Interrupt Control Register	DM0IC	XXXX X0002
006916	Timer B5 Interrupt Control Register	TB5IC	XXXX X0002
006A16	DMA2 Interrupt Control Register	DM2IC	XXXX X0002
006B16	UART2 Receive /ACK Interrupt Control Register	S2RIC	XXXX X0002
006C16	Timer A0 Interrupt Control Register	TA0IC	XXXX X0002
006D16	UART3 Receive /ACK Interrupt Control Register	S3RIC	XXXX X0002
006E16	Timer A2 Interrupt Control Register	TA2IC	XXXX X0002
006F16	UART4 Receive /ACK Interrupt Control Register	S4RIC	XXXX X0002
007016	Timer A4 Interrupt Control Register	TA4IC	XXXX X0002
007116	UART0/UART3 Bus Conflict Detect Interrupt Control Register	BCN0IC/BCN3IC	XXXX X0002
007216	UART0 Receive/ACK Interrupt Control Register	S0RIC	XXXX X0002
007316	A/D0 Conversion Interrupt Control Register	AD0IC	XXXX X0002
007416	UART1 Receive/ACK Interrupt Control Register	S1RIC	XXXX X0002
007516	Intelligent I/O Interrupt Control Register 0	IIO0IC	XXXX X0002
007616	Timer B1 Interrupt Control Register	TB1IC	XXXX X0002
007716	Intelligent I/O Interrupt Control Register 2	IIO2IC	XXXX X0002
007816	Timer B3 Interrupt Control Register	TB3IC	XXXX X0002
007916	Intelligent I/O Interrupt Control Register 4	IIO4IC	XXXX X0002
007A16	INT5 Interrupt Control Register	INT5IC	XX00 X0002
007B16			
007C16	INT3 Interrupt Control Register	INT3IC	XX00 X0002
007D16	Intelligent I/O Interrupt Control Register 8	IIO8IC	XXXX X0002
007E16	INT1 Interrupt Control Register	INT1IC	XX00 X0002
007F16	Intelligent I/O Interrupt Control Register 10/ CAN Interrupt 1 Control Register	IIO10IC CAN1IC	XXXX X0002
008016			
008116	CAN Interrupt 2 Control Register	CAN2IC	XXXX X0002
008216			
008316			
008416			
008516			
008616			
008716			
008816	DMA1 Interrupt Control Register	DM1IC	XXXX X0002
008916	UART2 Transmit /NACK Interrupt Control Register	S2TIC	XXXX X0002
008A16	DMA3 Interrupt Control Register	DM3IC	XXXX X0002
008B16	UART3 Transmit /NACK Interrupt Control Register	S3TIC	XXXX X0002
008C16	Timer A1 Interrupt Control Register	TA1IC	XXXX X0002
008D16	UART4 Transmit /NACK Interrupt Control Register	S4TIC	XXXX X0002
008E16	Timer A3 Interrupt Control Register	TA3IC	XXXX X0002
008F16	UART2 Bus Conflict Detect Interrupt Control Register	BCN2IC	XXXX X0002

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
012016	Base Timer Register 1	G1BT	XX16
012116			XX16
012216	Base Timer Control Register 10	G1BCR0	0016
012316	Base Timer Control Register 11	G1BCR1	X000 000X2
012416	Time Measurement Prescaler Register 16	G1TPR6	0016
012516	Time Measurement Prescaler Register 17	G1TPR7	0016
012616	Function Enable Register 1	G1FE	0016
012716	Function Select Register 1	G1FS	0016
012816	SI/O Receive Buffer Register 1	G1RB	XXXX XXXX2
012916			X000 XXXX2
012A16	Transmit Buffer/Receive Data Register 1	G1TB/G1DR	XX16
012B16			
012C16	Receive Input Register 1	G1RI	XX16
012D16	SI/O Communication Mode Register 1	G1MR	0016
012E16	Transmit Output Register 1	G1TO	XX16
012F16	SI/O Communication Control Register 1	G1CR	0000 X0112
013016	Data Compare Register 10	G1CMP0	XX16
013116	Data Compare Register 11	G1CMP1	XX16
013216	Data Compare Register 12	G1CMP2	XX16
013316	Data Compare Register 13	G1CMP3	XX16
013416	Data Mask Register 10	G1MSK0	XX16
013516	Data Mask Register 11	G1MSK1	XX16
013616			
013716			
013816	Receive CRC Code Register 1	G1RCRC	XX16
013916			XX16
013A16	Transmit CRC Code Register 1	G1TCRC	0016
013B16			0016
013C16	SI/O Extended Mode Register 1	G1EMR	0016
013D16	SI/O Extended Receive Control Register 1	G1ERC	0016
013E16	SI/O Special Communication Interrupt Detect Register 1	G1IRF	0016
013F16	SI/O Extended Transmit Control Register 1	G1ETC	0000 0XXX2
014016			
014116			
014216			
014316			
014416			
014516			
014616			
014716			
014816			
014916			
014A16			
014B16			
014C16			
014D16			
014E16			
014F16			

X: Indeterminate

Blank spaces are reserved. No access is allowed.

Address	Register	Symbol	Value after RESET
02F0₁₆			
02F1₁₆			
02F2₁₆			
02F3₁₆			
02F4₁₆	UART4 Special Mode Register 4	U4SMR4	00₁₆
02F5₁₆	UART4 Special Mode Register 3	U4SMR3	00₁₆
02F6₁₆	UART4 Special Mode Register 2	U4SMR2	00₁₆
02F7₁₆	UART4 Special Mode Register	U4SMR	00₁₆
02F8₁₆	UART4 Transmit/Receive Mode Register	U4MR	00₁₆
02F9₁₆	UART4 Bit Rate Register	U4BRG	XX₁₆
02FA₁₆	UART4 Transmit Buffer Register	U4TB	XX₁₆
02FB₁₆			XX₁₆
02FC₁₆	UART4 Transmit/Receive Control Register 0	U4C0	0000 1000₂
02FD₁₆	UART4 Transmit/Receive Control Register 1	U4C1	0000 0010₂
02FE₁₆	UART4 Receive Buffer Register	U4RB	XX₁₆
02FF₁₆			XX₁₆
0300₁₆	Timer B3, B4, B5 Count Start Flag	TBSR	000X XXXX₂
0301₁₆			
0302₁₆	Timer A1-1 Register	TA11	XX₁₆
0303₁₆			XX₁₆
0304₁₆	Timer A2-1 Register	TA21	XX₁₆
0305₁₆			XX₁₆
0306₁₆	Timer A4-1 Register	TA41	XX₁₆
0307₁₆			XX₁₆
0308₁₆	Three-Phase PWM Control Register 0	INVC0	00₁₆
0309₁₆	Three-Phase PWM Control Register 1	INVC1	00₁₆
030A₁₆	Three-Phase Output Buffer Register 0	IDB0	XX11 1111₂
030B₁₆	Three-Phase Output Buffer Register 1	IDB1	XX11 1111₂
030C₁₆	Dead Time Timer	DTT	XX₁₆
030D₁₆	Timer B2 Interrupt Generation Frequency Set Counter	ICTB2	XX₁₆
030E₁₆			
030F₁₆			
0310₁₆	Timer B3 Register	TB3	XX₁₆
0311₁₆			XX₁₆
0312₁₆	Timer B4 Register	TB4	XX₁₆
0313₁₆			XX₁₆
0314₁₆	Timer B5 Register	TB5	XX₁₆
0315₁₆			XX₁₆
0316₁₆			
0317₁₆			
0318₁₆			
0319₁₆			
031A₁₆			
031B₁₆	Timer B3 Mode Register	TB3MR	00XX 0000₂
031C₁₆	Timer B4 Mode Register	TB4MR	00XX 0000₂
031D₁₆	Timer B5 Mode Register	TB5MR	00XX 0000₂
031E₁₆			
031F₁₆	External Interrupt Cause Select Register	IFSR	00₁₆

X: Indeterminate

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5. Electrical Characteristics

5.1 Electrical Characteristics (M32C/84)

Table 5.1 Absolute Maximum Ratings

Symbol	Parameter		Condition	Value	Unit
V_{CC1}, V_{CC2}	Supply Voltage		V_{CC1}=AV$_{CC}$	-0.3 to 6.0	V
V_{CC2}	Supply Voltage		-	-0.3 to V_{CC1}	V
AV$_{CC}$	Analog Supply Voltage		V_{CC1}=AV$_{CC}$	-0.3 to 6.0	V
V_I	Input Voltage	$\overline{RESET}$, CNV$_{SS}$, BYTE, P6$_0$-P6$_7$, P7$_2$-P7$_7$, P8$_0$-P8$_7$, P9$_0$-P9$_7$, P10$_0$-P10$_7$, P14$_0$-P14$_6$, P15$_0$-P15$_7$(1), V_{REF}, X_{IN}		-0.3 to V_{CC1}+0.3	V
		P0$_0$-P0$_7$, P1$_0$-P1$_7$, P2$_0$-P2$_7$, P3$_0$-P3$_7$, P4$_0$-P4$_7$, P5$_0$-P5$_7$, P11$_0$-P11$_4$, P12$_0$-P12$_7$, P13$_0$-P13$_7$(1)		-0.3 to V_{CC2}+0.3	
		P7$_0$, P7$_1$		-0.3 to 6.0	
V_O	Output Voltage	P6$_0$-P6$_7$, P7$_2$-P7$_7$, P8$_0$-P8$_4$, P8$_6$, P8$_7$, P9$_0$-P9$_7$, P10$_0$-P10$_7$, P14$_0$-P14$_6$, P15$_0$-P15$_7$(1), X_{OUT}		-0.3 to V_{CC1}+0.3	V
		P0$_0$-P0$_7$, P1$_0$-P1$_7$, P2$_0$-P2$_7$, P3$_0$-P3$_7$, P4$_0$-P4$_7$, P5$_0$-P5$_7$, P11$_0$-P11$_4$, P12$_0$-P12$_7$, P13$_0$-P13$_7$(1)		-0.3 to V_{CC2}+0.3	
		P7$_0$, P7$_1$		-0.3 to 6.0	
Pd	Power Dissipation		Topr=25° C	500	mW
Topr	Operating Ambient Temperature	during CPU operation		-20 to 85/ -40 to 85(2)	° C
		during flash memory program and erase operation		0 to 60	
Tstg	Storage Temperature			-65 to 150	° C

NOTES:
1. P11 to P15 are provided in the 144-pin package only.
2. Contact Renesas Technology Sales Co., Ltd, if temperature range of -40 to 85° C is required.

Table 5.2 Recommended Operating Conditions (Continued)
(V_{CC1}=V_{CC2}=3.0V to 5.5V at Topr=–20 to 85°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
$f(BCLK)$	CPU Clock Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
		V_{CC1}=3.0 to 5.5V	0		24	MHz
$f(X_{IN})$	Main Clock Input Frequency	V_{CC1}=4.2 to 5.5V	0		32	MHz
		V_{CC1}=3.0 to 5.5V	0		24	MHz
$f(X_{CIN})$	Sub Clock Frequency			32.768	50	kHz
$f(Ring)$	On-chip Oscillator Frequency (V_{CC1}=V_{CC2}=5.0V, Topr=25° C)		0.5	1	2	MHz
$f(PLL)$	PLL Clock Frequency	V_{CC1}=4.2 to 5.5V	10		32	MHz
		V_{CC1}=3.0 to 5.5V	10		24	MHz
$t_{SU(PLL)}$	Wait Time to Stabilize PLL Frequency Synthesizer	V_{CC1}=5.0V			5	ms
		V_{CC1}=3.3V			10	ms

$V_{CC1}=V_{CC2}=5V$

Table 5.6 Flash Memory Version Electrical Characteristics (V_{CC1}=4.5 to 5.5V, 3.3 to 3.6V at Topr=0 to 60°C unless otherwise specified)

Symbol	Parameter		Standard			Unit
			Min.	Typ.	Max.	
-	Program and Erase Endurance(2)		100			cycles
-	Word Program Time (V_{CC1}=5.0V, Topr=25° C)			25	200	µs
-	Lock Bit Program Time			25	200	µs
-	Block Erase Time (V_{CC1}=5.0V, Topr=25° C)	4-Kbyte Block		0.3	4	s
		8-Kbyte Block		0.3	4	s
		32-Kbyte Block		0.5	4	s
		64-Kbyte Block		0.8	4	s
-	All-Unlocked-Block Erase Time(1)				4 x *n*	s
t_{PS}	Wait Time to Stabilize Flash Memory Circuit				15	µs
-	Data Hold Time (Topr=-40 to 85 ° C)		10			years

NOTES:
1. *n* denotes the number of block to be erased.
2. Number of program-erase cycles per block.
   If Program and Erase Endurance is *n* cycle (*n*=100), each block can be erased and programmed *n* cycles. For example, if a 4-Kbyte block A is erased after programming a word data 2,048 times, each to a different address, this counts as one program and erase endurance. Data can not be programmed to the same address more than once without erasing the block. (rewrite prohibited).

$V_{CC1}=V_{CC2}=5V$

Table 5.7 Voltage Detection Circuit Electrical Characteristics ($V_{CC1}=V_{CC2}=3.0$ to 5.5V, Vss=0V at Topr=25°C unless otherwise specified)

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
Vdet4	Low Voltage Detection Voltage(1)	V_{CC1}=3.0 to 5.5V		3.8		V
Vdet3	Reset Space Detection Voltage(1)			3.0		V
Vdet3s	Low Voltage Reset Hold Voltage		2.0			V
Vdet3r	Low Voltage Reset Release Voltage(2)			3.1		V

NOTES:
1. Vdet4 >Vdet3
2. Vdet3r >Vdet3 is not guaranteed.

Table 5.8 Power Supply Timing

Symbol	Parameter	Measurement Condition	Standard			Unit
			Min.	Typ.	Max.	
td(P-R)	Wait Time to Stabilize Internal Supply Voltage when Power-on	V_{CC1}=3.0 to 5.5V			2	ms
td(S-R)	Wait Time to Release Brown-out. Detection Reset	V_{CC1}=Vdet3r to 5.5V		6(1)	20	ms
td(E-A)	Start-up Time for Low Voltage Detection Circuit Operation	V_{CC1}=3.0 to 5.5V			20	µs

NOTES:
1. V_{CC1}=5V

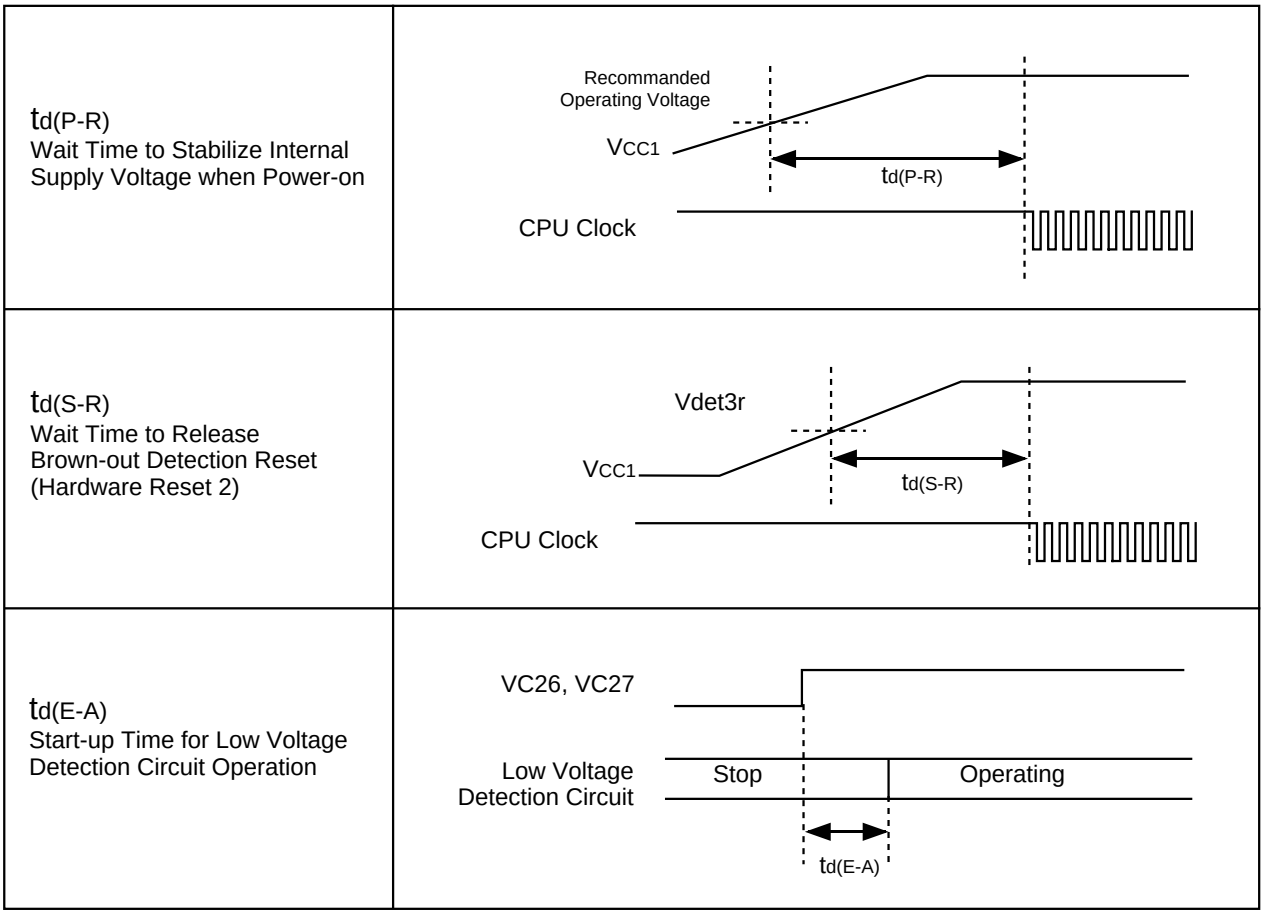


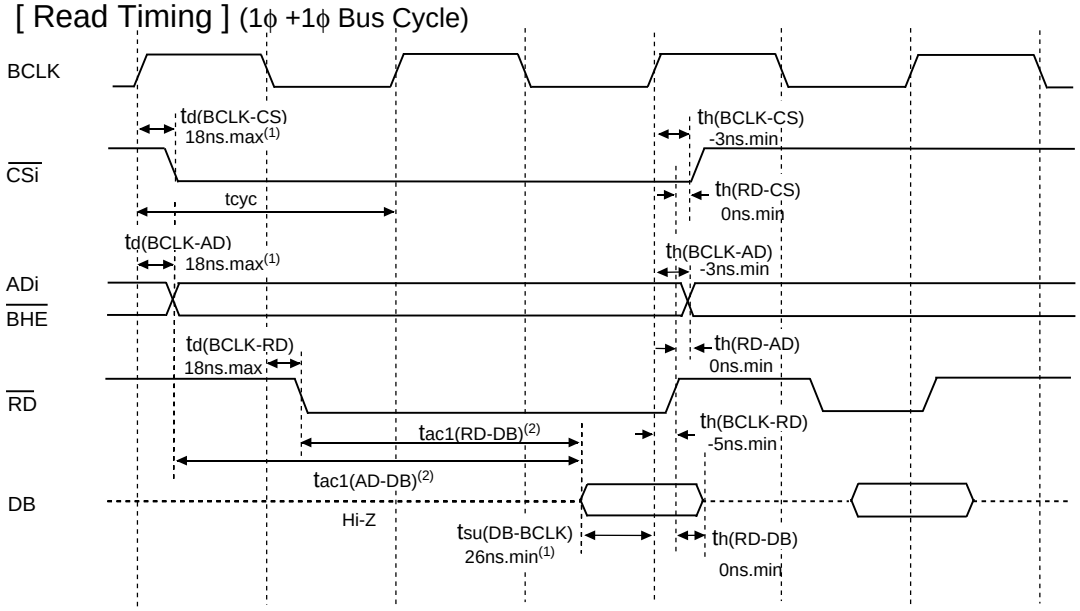
Figure 5.1 Power Supply Timing Diagram

Vcc1=Vcc2=5V

Memory Expansion Mode and Microprocessor Mode

(when accessing an external memory space)

[Read Timing] (1ϕ +1ϕ Bus Cycle)



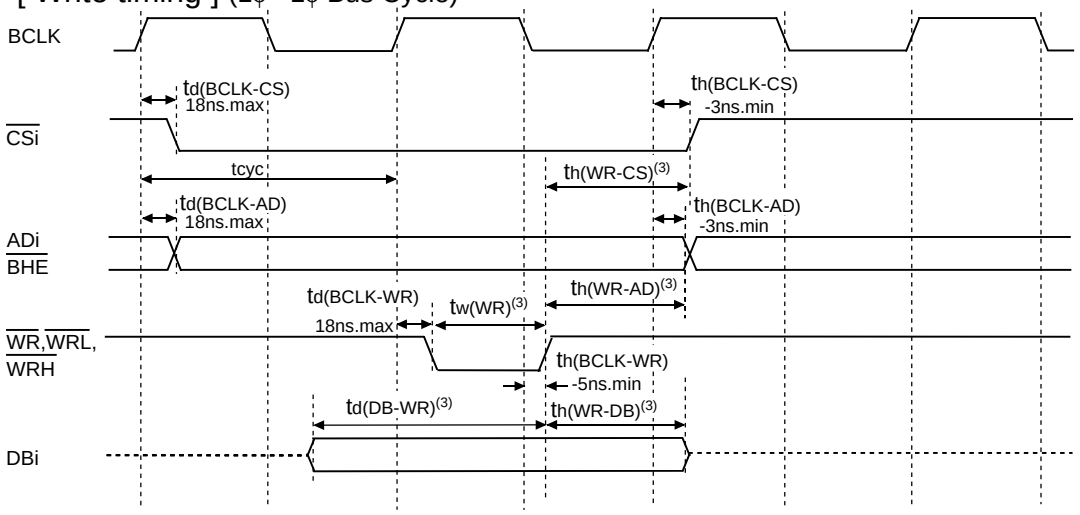
NOTES:

1. Values guaranteed only when the microcomputer is used independently.
A maximum of 35ns is guaranteed for $t_{d(BCLK-AD)}+t_{su(DB-BCLK)}$.
2. Varies with operation frequency:

$t_{ac1(RD-DB)}$=(tcyc/2 x m-35)ns.max (if external bus cycle is aϕ + bϕ, m=(b x 2)+1)

$t_{ac1(AD-DB)}$=(tcyc x n-35)ns.max (if external bus cycle is aϕ + bϕ, n=a+b)

[Write timing] (1ϕ +1ϕ Bus Cycle)



NOTES:

3. Varies with operation frequency:
$t_{d(DB-WR)}$=(tcyc x m-20)ns.min
(if external bus cycle is aϕ+bϕ, m=b)
$t_{h(WR-DB)}$=(tcyc/2-10)ns.min
$t_{h(WR-AD)}$=(tcyc/2-10)ns.min
$t_{h(WR-CS)}$=(tcyc/2-10)ns.min
$t_{w(WR)}$=(tcyc/2 x n-15)ns.min
(if external bus cycle is aϕ+bϕ , n=(bx2)-1)

Measurement Conditions:

- V_{CC1}=V_{CC2}=4.2 to 5.5V
- Input high and low voltage: V_{IH}=2.5V, V_{IL}=0.8V
- Output high and low voltage: V_{OH}=2.0V, V_{OL}=0.8V

$$tcyc = \frac{10^9}{f(BCLK)}$$

Figure 5.3 Vcc1=Vcc2=5V Timing Diagram (1)

$V_{CC1}=V_{CC2}=3.3V$

Switching Characteristics

(V_{CC1} = V_{CC2} = 3.0 to 3.6V, VSS = 0V at Topr = –20 to 85°C unless otherwise specified)

Table 5.41 Memory Expansion Mode and Microprocessor Mode (when accessing an external memory space with the multiplexed bus)

Symbol	Parameter	Measurement Condition	Standard		Unit
			Min.	Max.	
td(BCLK-AD)	Address Output Delay Time	See Figure 5.2		18	ns
th(BCLK-AD)	Address Output Hold Time (BCLK standard)		0		ns
th(RD-AD)	Address Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-AD)	Address Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-CS)	Chip-Select Signal Output Delay Time			18	ns
th(BCLK-CS)	Chip-Select Signal Output Hold Time (BCLK standard)		0		ns
th(RD-CS)	Chip-Select Signal Output Hold Time (RD standard)(5)		(Note 1)		ns
th(WR-CS)	Chip-Select Signal Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-RD)	RD Signal Output Delay Time			18	ns
th(BCLK-RD)	RD Signal Output Hold Time		-3		ns
td(BCLK-WR)	WR Signal Output Delay Time			18	ns
th(BCLK-WR)	WR Signal Output Hold Time		0		ns
td(DB-WR)	Data Output delay Time (WR standard)		(Note 2)		ns
th(WR-DB)	Data Output Hold Time (WR standard)(5)		(Note 1)		ns
td(BCLK-ALE)	ALE Signal Output Delay Time (BCLK standard)			18	ns
th(BCLK-ALE)	ALE Signal Output Hold Time (BCLK standard)		-2		ns
td(AD-ALE)	ALE Signal Output Delay Time (address standard)		(Note 3)		ns
th(ALE-AD)	ALE Signal Output Hold Time (address standard)		(Note 4)		ns
tdz(RD-AD)	Address Output Float Start Time			8	ns

NOTES:

1. Values can be obtained by the following equations, according to BLCK frequency.

$$th(RD-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-AD) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(RD-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-CS) = \frac{10^9}{f(BCLK) \times 2} - 10 \quad [ns]$$

$$th(WR-DB) = \frac{10^9}{f(BCLK) \times 2} - 20 \quad [ns]$$

2. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$td(DB-WR) = \frac{10^9 \times m}{f(BCLK) \times 2} - 25 \quad [ns]$$ (if external bus cycle is aφ + bφ, m=(b+2)-1)

3. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$td(AD-ALE) = \frac{10^9 \times n}{f(BCLK) \times 2} - 20 \quad [ns]$$ (if external bus cycle is aφ + bφ, n=a)

4. Values can be obtained by the following equations, according to BLCK frequency and external bus cycles.

$$th(ALE-AD) = \frac{10^9 \times n}{f(BCLK) \times 2} - 10 \quad [ns]$$ (if external bus cycle is aφ + bφ, n=a)

5. *tc* ns is added when recovery cycle is inserted.

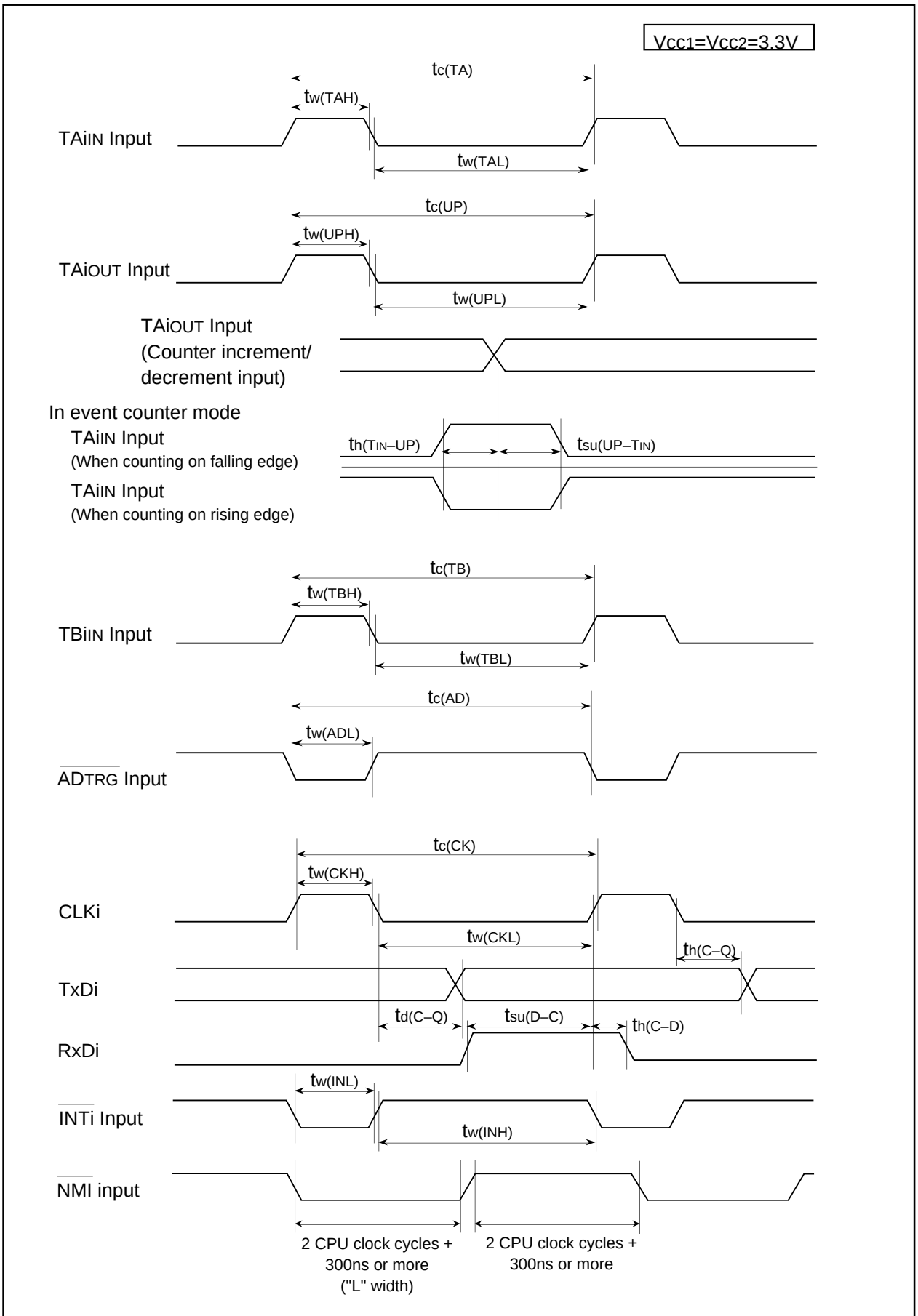
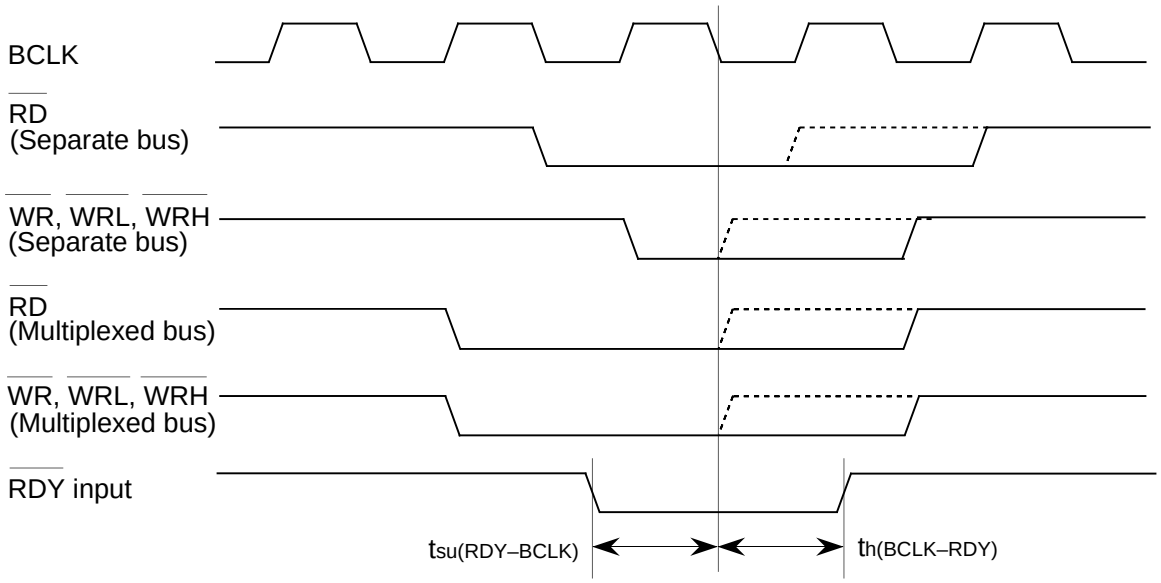
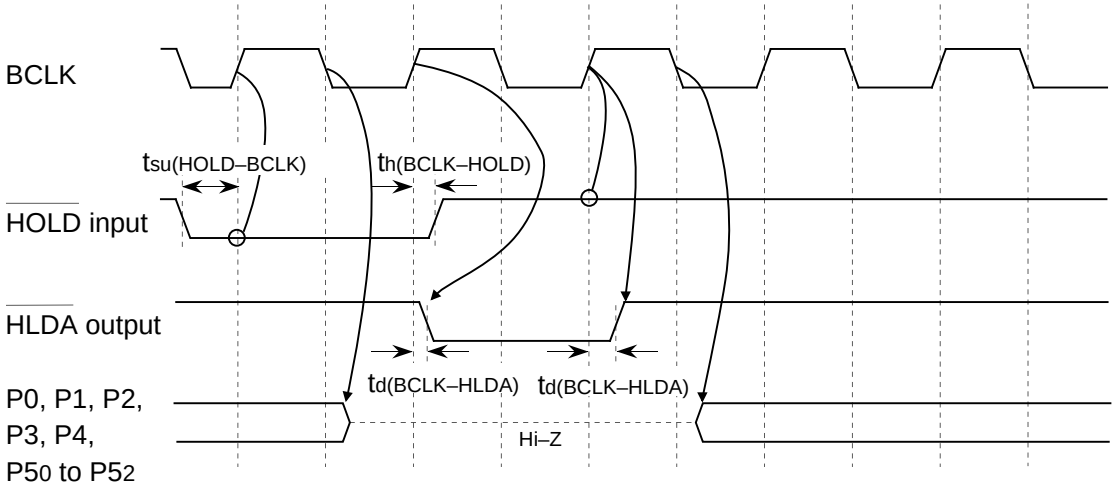


Figure 5.9 Vcc1=Vcc2=3.3V Timing Diagram (3)

$V_{CC1}=V_{CC2}=3.3V$

Memory Expansion Mode and Microprocessor Mode





Measurement Conditions:
- $V_{CC1}=V_{CC2}=3.0$ to 3.6V
- Input high and low voltage: $V_{IH}=2.4V$, $V_{IL}=0.6V$
- Output high and low voltage: $V_{OH}=1.5V$, $V_{OL}=1.5V$

Figure 5.10 $V_{CC1}=V_{CC2}=3.3V$ Timing Diagram (4)

$V_{CC1}=V_{CC2}=5V$

Timing Requirements

($V_{CC1}=V_{CC2}=4.2$ to 5.5V, $V_{SS}=0V$ at Topr= -40 to 85°C (T version) unless otherwise specified)

Table 5.50 Timer A Input (Count Source Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	100		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	40		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	40		ns

Table 5.51 Timer A Input (Gate Input in Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	400		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	200		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	200		ns

Table 5.52 Timer A Input (External Trigger Input in One-Shot Timer Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TA)}$	TAi_{IN} Input Cycle Time	200		ns
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.53 Timer A Input (External Trigger Input in Pulse Width Modulation Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(TAH)}$	TAi_{IN} Input High ("H") Width	100		ns
$t_{w(TAL)}$	TAi_{IN} Input Low ("L") Width	100		ns

Table 5.54 Timer A Input (Counter Increment/Decrement Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(UP)}$	TAi_{OUT} Input Cycle Time	2000		ns
$t_{w(UPH)}$	TAi_{OUT} Input High ("H") Width	1000		ns
$t_{w(UPL)}$	TAi_{OUT} Input Low ("L") Width	1000		ns
$t_{su(UP-TIN)}$	TAi_{OUT} Input Setup Time	400		ns
$t_{h(TIN-UP)}$	TAi_{OUT} Input Hold Time	400		ns